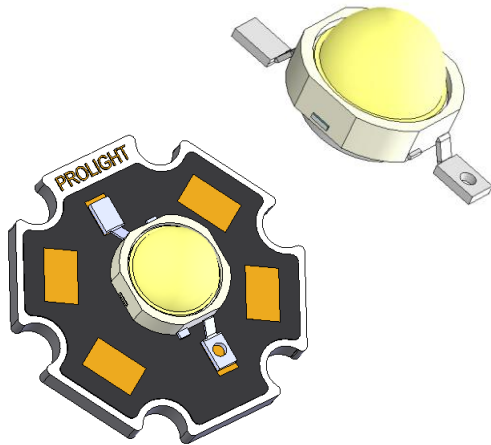




ProLight Opto
Technology Corporation



**ProLight PG1A-5Dxx
5W Power LED
Technical Datasheet
Version: 4.3**

Features

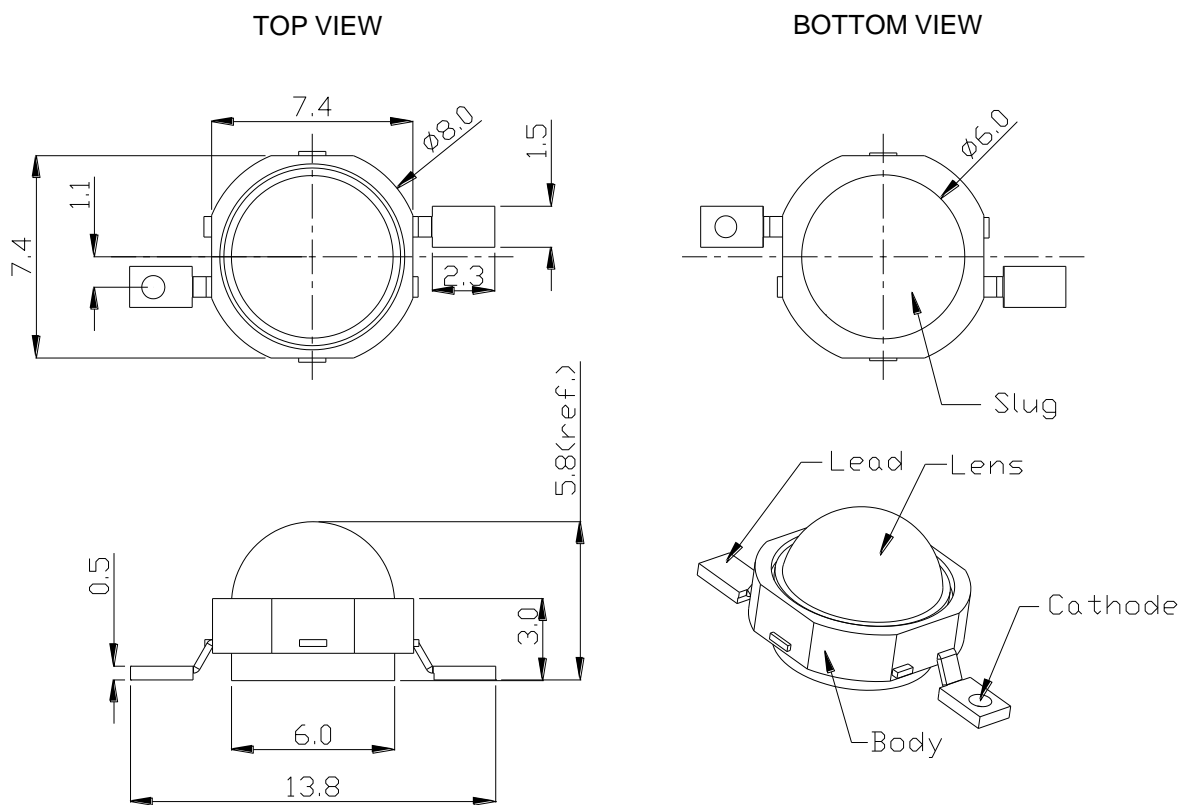
- High flux per LED
- Various colors
- Good color uniformity
- Moisture sensitivity level - JEDEC Level 2a
4 week floor life without reconditioning
- Low-temp. & lead free reflow soldering
- RoHS compliant
- More energy efficient than incandescent and most halogen lamps
- Low Voltage DC operated
- Instant light (less than 100ns)
- No UV
- Superior ESD protection

Typical Applications

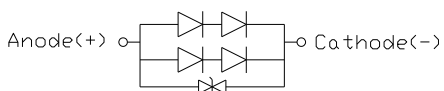
- Reading lights (car, bus, aircraft)
- Portable (flashlight, bicycle)
- Uplighters/Downlighters
- Decorative/Entertainment
- Bollards/Security/Garden
- Cove/Undersheff/Task
- Indoor/Outdoor Commercial and Residential Architectural
- Automotive Ext (Stop-Tail-Turn, CHMSL, Mirror Side Repeat)
- LCD backlights

ProLight

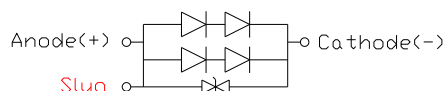
Emitter Mechanical Dimensions



Circuit Diagram (W,WW,G,B)



Circuit Diagram (R,A)

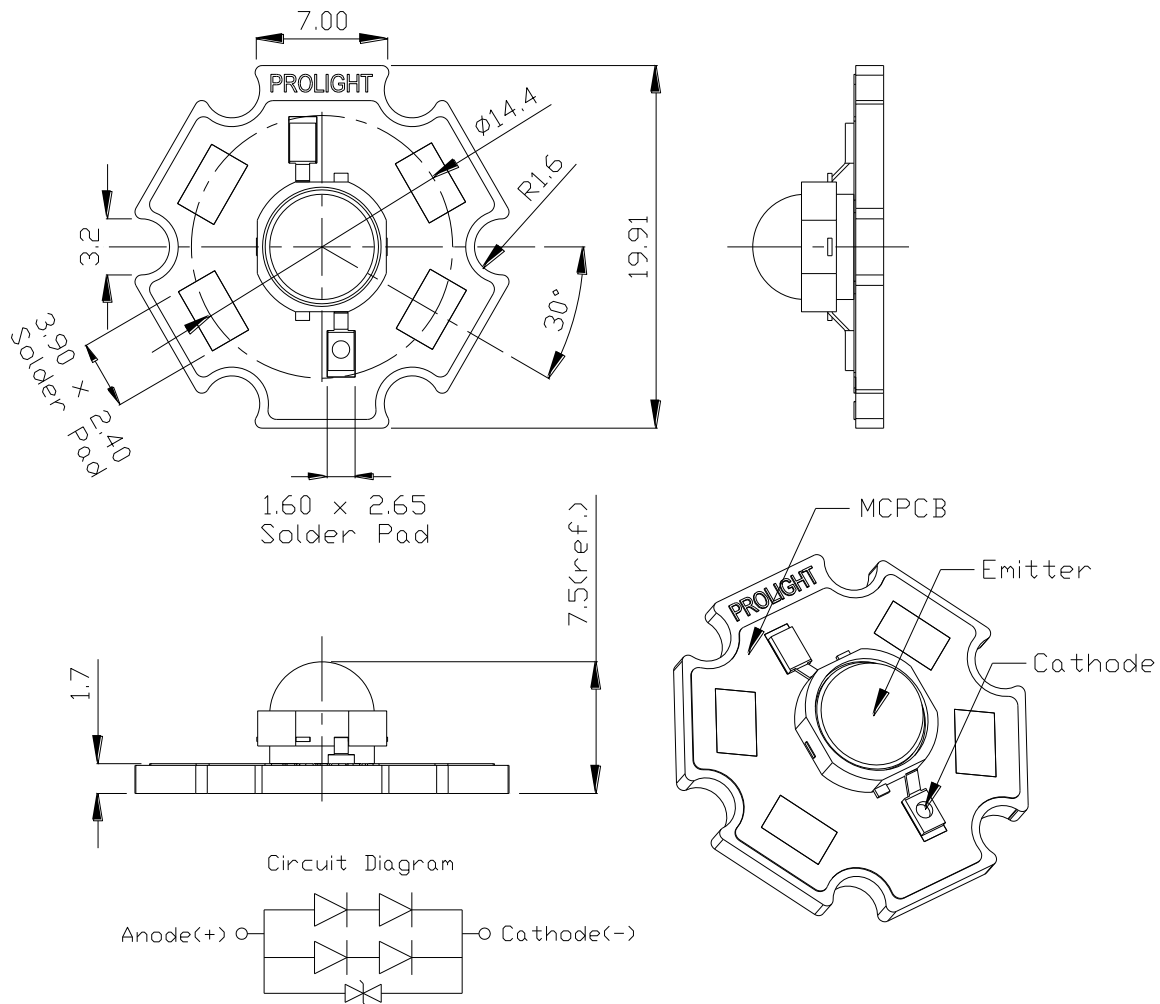


Notes:

1. The cathode side of the device is denoted by a hole in the lead frame.
2. Electrical insulation between the case and the board is required. Do not electrically connect either the anode or cathode to the slug.
3. Drawing not to scale.
4. All dimensions are in millimeters.
5. Unless otherwise indicated, tolerances are ± 0.20 mm.
6. Please do not bend the leads of the LED, otherwise it will damage the LED.
7. **Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

*The appearance and specifications of the product may be modified for improvement without notice.

Star Mechanical Dimensions



Notes:

1. Slots in aluminum-core PCB for M3 or #4 mounting screw.
2. Electrical interconnection pads labeled on the aluminum-core PCB with "+" and "-" to denote positive and negative, respectively. All positive pads are interconnected, as are all negative pads, allowing for flexibility in array interconnection.
3. Drawing not to scale.
4. All dimensions are in millimeters.
5. Unless otherwise indicated, tolerances are ± 0.20 mm.
6. **Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

*The appearance and specifications of the product may be modified for improvement without notice.

ProLight

Flux Characteristics at 700mA, T_J = 25°C

Radiation Pattern	Color	Part Number		Lumious Flux Φ_V (lm)	
		Emitter	Star	Minimum	Typical
Dome	White	PG1A-5DWE	PG1A-5DWS	369.9	495
	Warm White	PG1A-5DVE	PG1A-5DVS	369.9	475
	Red	PG1A-5DRE	PG1A-5DRS	168.4	200
	Amber	PG1A-5DAE	PG1A-5DAS	168.4	200
	Green	PG1A-5DGE	PG1A-5DGS	249.6	340
	Blue	PG1A-5DBE	PG1A-5DBS	67.2	80

- ProLight maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics at 700mA, T_J = 25°C

Color	Forward Voltage V _F (V)			Thermal Resistance Junction to Slug (°C/ W)	Thermal Resistance Junction to Board (°C/ W)
	Min.	Typ.	Max.		
White	5.7	6.8	8.2	3	5
Warm White	5.7	6.8	8.2	3	5
Red	3.5	4.4	6.2	3	5
Amber	3.5	4.4	6.2	3	5
Green	5.7	6.8	8.2	3	5
Blue	5.7	6.8	8.2	3	5

- ProLight maintains a tolerance of $\pm 0.1V$ for Voltage measurements.

Optical Characteristics at 700mA, T_J = 25°C

Color	Dominant Wavelength λ_D , or Color Temperature CCT			Total included Angle (degrees)	Viewing Angle (degrees)
	Min.	Typ.	Max.	$\theta_{0.90V}$	$2 \theta_{1/2}$
White	4100 K	5500 K	10000 K	90	70
Warm White	2700 K	3300 K	4100 K	90	70
Red	613.5 nm	623 nm	631 nm	90	70
Amber	587 nm	592 nm	597 nm	90	70
Green	515 nm	525 nm	535 nm	90	70
Blue	455 nm	465 nm	475 nm	90	70

- ProLight maintains a tolerance of $\pm 1nm$ for dominant wavelength measurements.
- ProLight maintains a tolerance of $\pm 5\%$ for CCT measurements.

ProLight

Absolute Maximum Ratings

Parameter	White/Warm White/ Red/Amber/Green/Blue
DC Forward Current (mA)	700
Peak Pulsed Forward Current (mA)	1000 (less than 1/10 duty cycle@1KHz)
Average Forward Current (mA)	700
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	±4000V (Class III)
LED Junction Temperature	120°C
Operating Board Temperature at Maximum DC Forward Current	-40°C - 95°C
Storage Temperature	-40°C - 120°C
Soldering Temperature	JEDEC 020c 235°C
Allowable Reflow Cycles	3
Reverse Voltage	Not designed to be driven in reverse bias

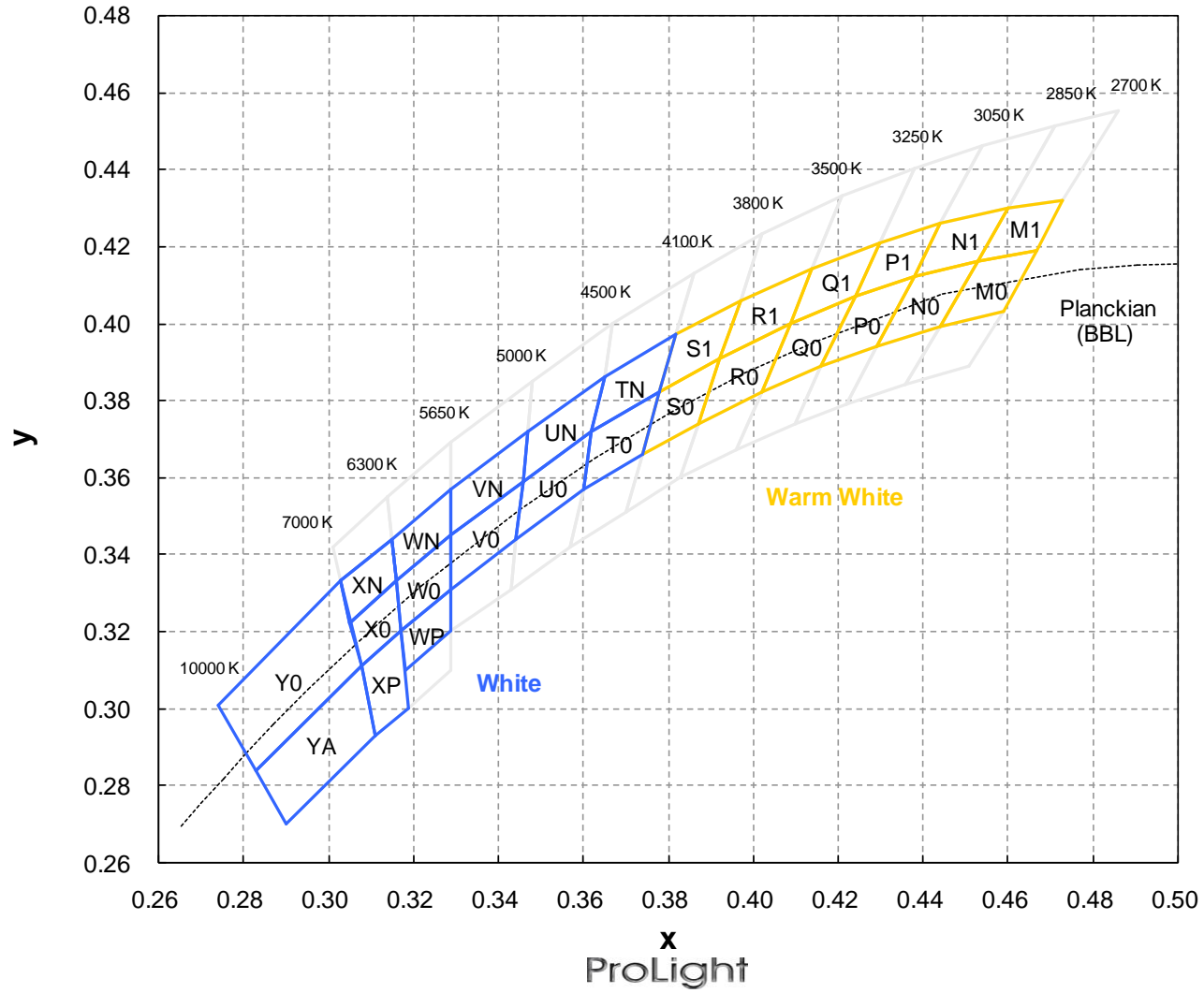
Photometric Luminous Flux Bin Structure

Color	Bin Code	Minimum Photometric Flux (lm)	Maximum Photometric Flux (lm)	Available Color Bins
White	Z2	369.9	421.9	All
	Z3	421.9	480	All
	Z4	480	550	Xx, Wx, Vx ^[1]
	Z5	550	630	[1]
Warm White	Z2	369.9	421.9	All
	Z3	421.9	480	All
	Z4	480	550	[1]
Red	W2	168.4	192	All
	X1	192	218.9	All
	X2	218.9	249.6	[1]
Amber	W2	168.4	192	All
	X1	192	218.9	All
	X2	218.9	249.6	[1]
Green	Y1	249.6	284.5	All
	Y2	284.5	324.5	All
	Z1	324.5	369.9	All
	Z2	369.9	421.9	[1]
Blue	T1	67.2	76.6	A, 1 ^[1]
	T2	76.6	87.4	A, 1 ^[1]
	U1	87.4	99.6	[1]

- ProLight maintains a tolerance of ± 10% on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

Color Bin

White and Warm White Binning Structure Graphical Representation



Color Bins

White Bin Structure

Bin Code	x	y	Typ. CCT (K)	Bin Code	x	y	Typ. CCT (K)
T0	0.378	0.382	4300	WN	0.329	0.345	5970
	0.374	0.366			0.316	0.333	
	0.360	0.357			0.315	0.344	
	0.362	0.372			0.329	0.357	
TN	0.382	0.397	4300	WP	0.329	0.331	5970
	0.378	0.382			0.329	0.320	
	0.362	0.372			0.318	0.310	
	0.365	0.386			0.317	0.320	
U0	0.362	0.372	4750	X0	0.308	0.311	6650
	0.360	0.357			0.305	0.322	
	0.344	0.344			0.316	0.333	
	0.346	0.359			0.317	0.320	
UN	0.365	0.386	4750	XN	0.305	0.322	6650
	0.362	0.372			0.303	0.333	
	0.346	0.359			0.315	0.344	
	0.347	0.372			0.316	0.333	
V0	0.329	0.331	5320	XP	0.308	0.311	6650
	0.329	0.345			0.317	0.320	
	0.346	0.359			0.319	0.300	
	0.344	0.344			0.311	0.293	
VN	0.329	0.345	5320	Y0	0.308	0.311	8000
	0.329	0.357			0.283	0.284	
	0.347	0.372			0.274	0.301	
	0.346	0.359			0.303	0.333	
W0	0.329	0.345	5970	YA	0.308	0.311	8000
	0.329	0.331			0.311	0.293	
	0.317	0.320			0.290	0.270	
	0.316	0.333			0.283	0.284	

- Tolerance on each color bin (x , y) is ± 0.01

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Color Bins

Warm White Bin Structure

Bin Code	x	y	Typ. CCT (K)	Bin Code	x	y	Typ. CCT (K)
M0	0.453	0.416	2770	Q0	0.409	0.400	3370
	0.444	0.399			0.402	0.382	
	0.459	0.403			0.416	0.389	
	0.467	0.419			0.424	0.407	
M1	0.460	0.430	2770	Q1	0.414	0.414	3370
	0.453	0.416			0.409	0.400	
	0.467	0.419			0.424	0.407	
	0.473	0.432			0.430	0.421	
N0	0.438	0.412	2950	R0	0.392	0.391	3650
	0.429	0.394			0.387	0.374	
	0.444	0.399			0.402	0.382	
	0.453	0.416			0.409	0.400	
N1	0.444	0.426	2950	R1	0.414	0.414	3650
	0.438	0.412			0.409	0.400	
	0.453	0.416			0.392	0.391	
	0.460	0.430			0.397	0.406	
P0	0.424	0.407	3150	S0	0.392	0.391	3950
	0.416	0.389			0.387	0.374	
	0.429	0.394			0.374	0.366	
	0.438	0.412			0.378	0.382	
P1	0.430	0.421	3150	S1	0.397	0.406	3950
	0.424	0.407			0.392	0.391	
	0.438	0.412			0.378	0.382	
	0.444	0.426			0.382	0.397	

- Tolerance on each color bin (x , y) is ± 0.01

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Dominant Wavelength Bin Structure

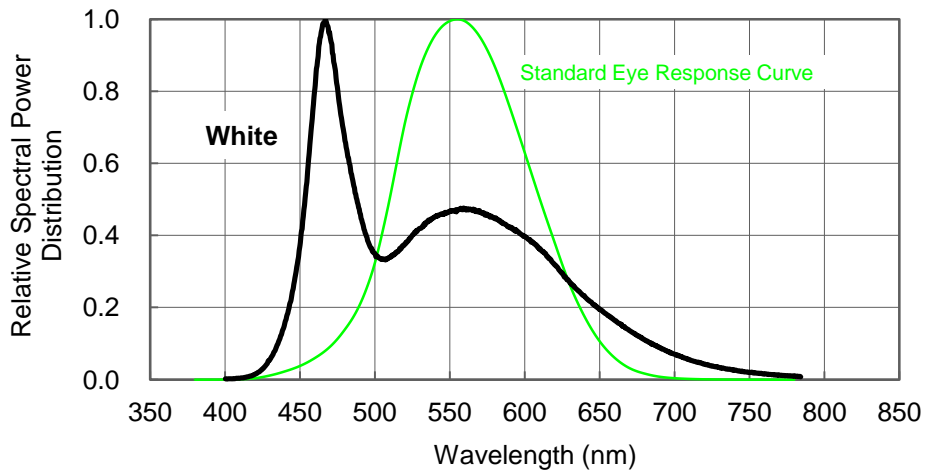
Color	Bin Code	Minimum Dominant Wavelength (nm)	Maximum Dominant Wavelength (nm)
Red	2	613.5	620.5
	4	620.5	631.0
Amber	2	587.0	589.5
	4	589.5	592.0
	6	592.0	594.5
	7	594.5	597.0
Green	A	515	520
	1	520	525
	2	525	530
	3	530	535
Blue	A	455	460
	1	460	465
	2	465	470
	3	470	475

- ProLight maintains a tolerance of ± 1 nm for dominant wavelength measurements.

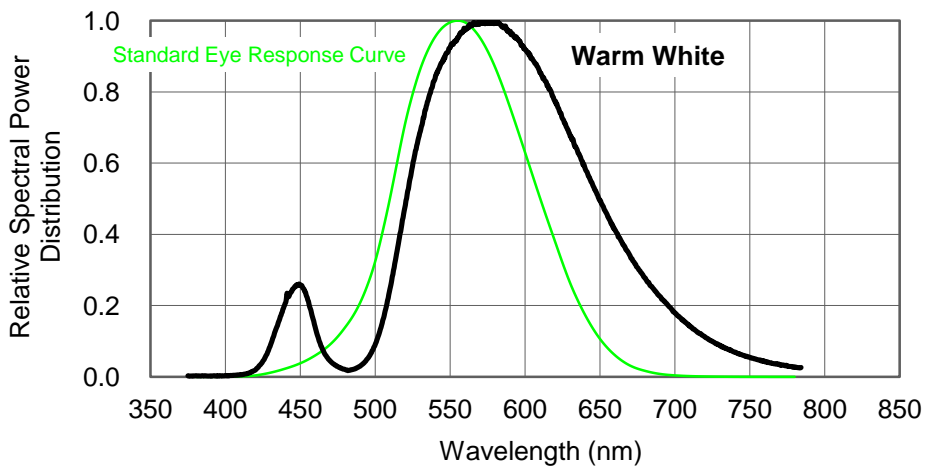
Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Color Spectrum, $T_J = 25^\circ\text{C}$

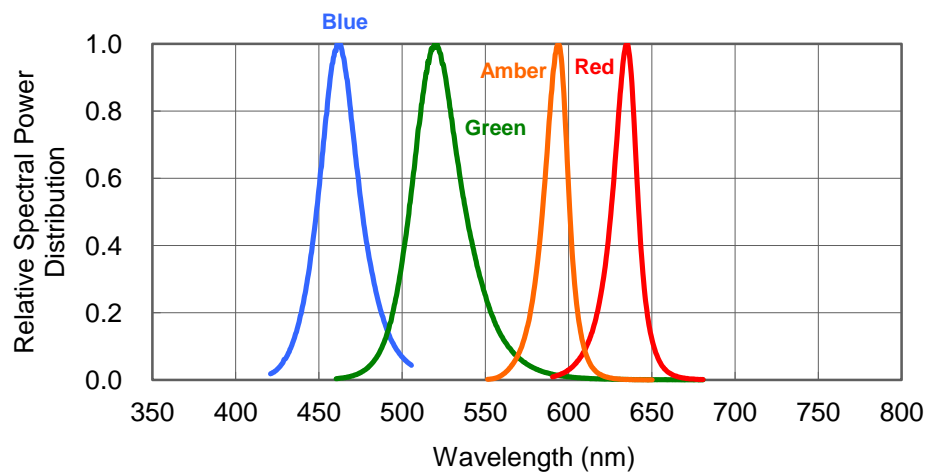
1. White



2. Warm White



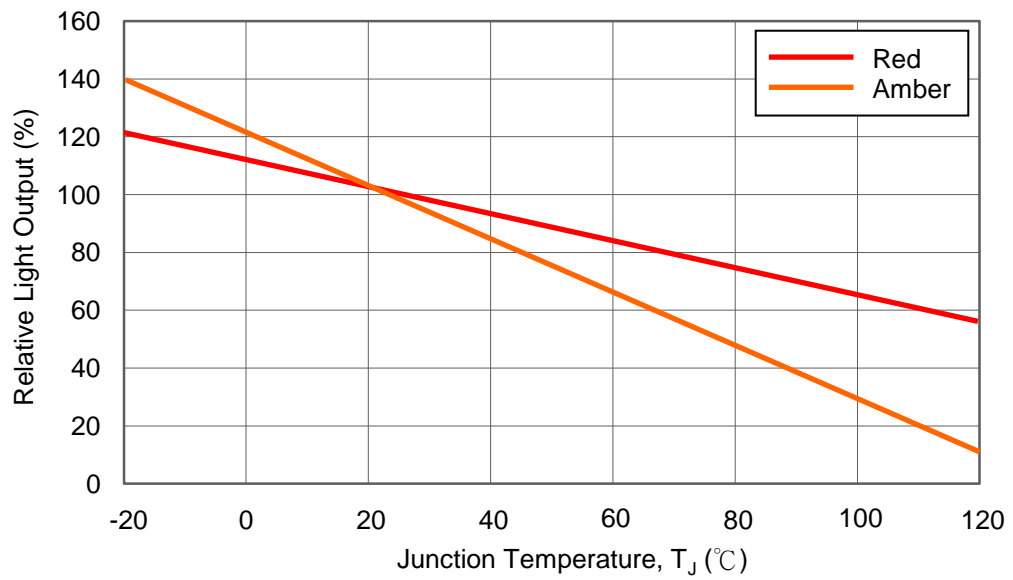
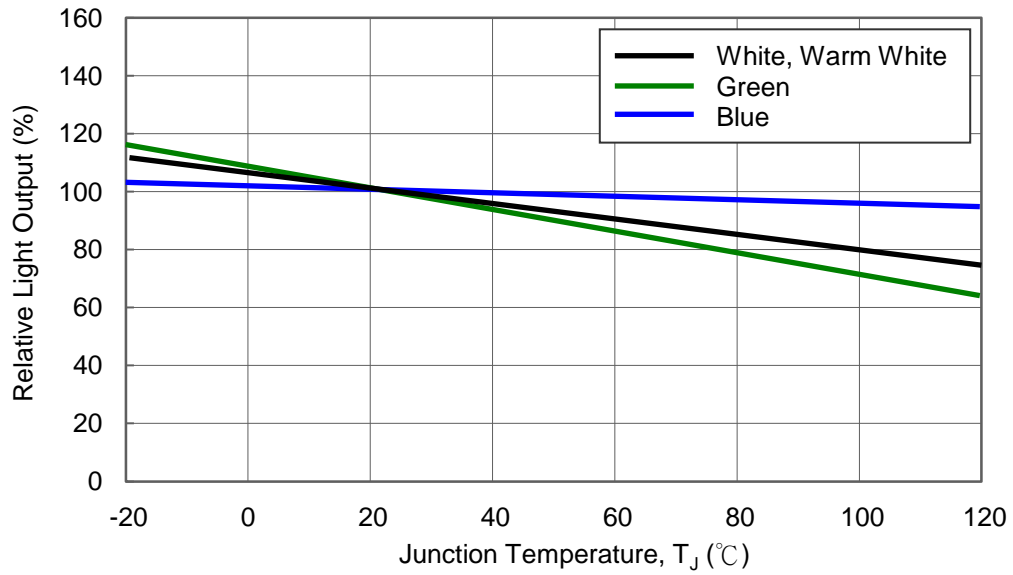
3. Blue 、 Green 、 Amber 、 Red



ProLight

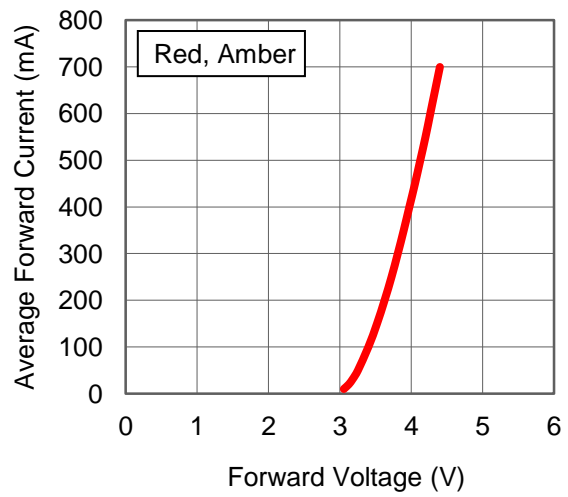
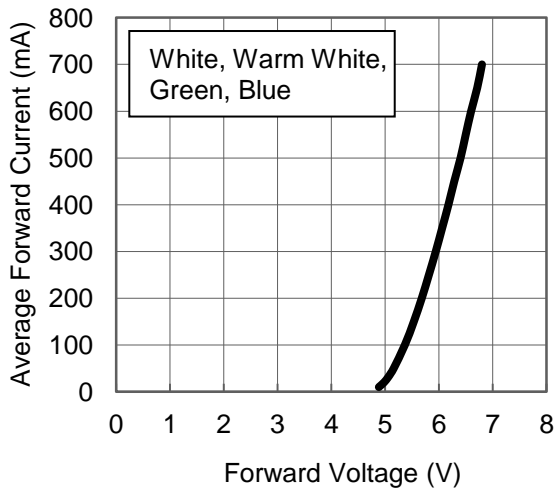
Light Output Characteristics

Relative Light Output vs. Junction Temperature at 700mA

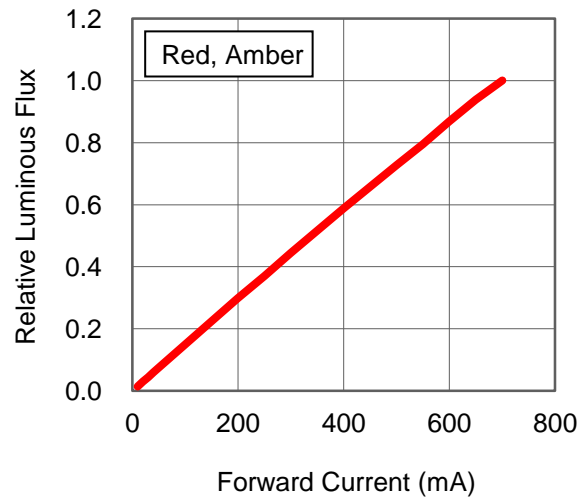
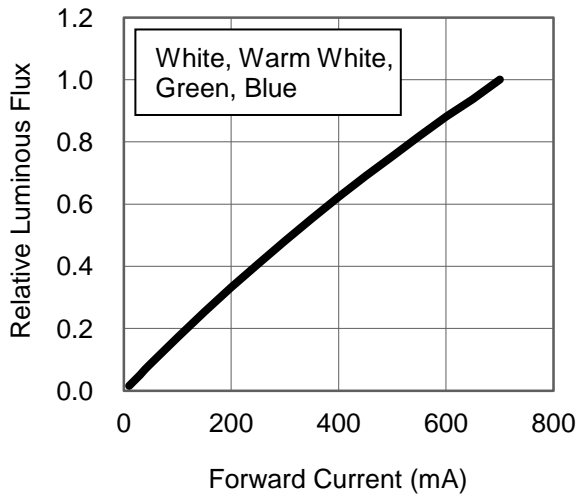


Forward Current Characteristics, $T_J = 25^\circ\text{C}$

1. Forward Voltage vs. Forward Current

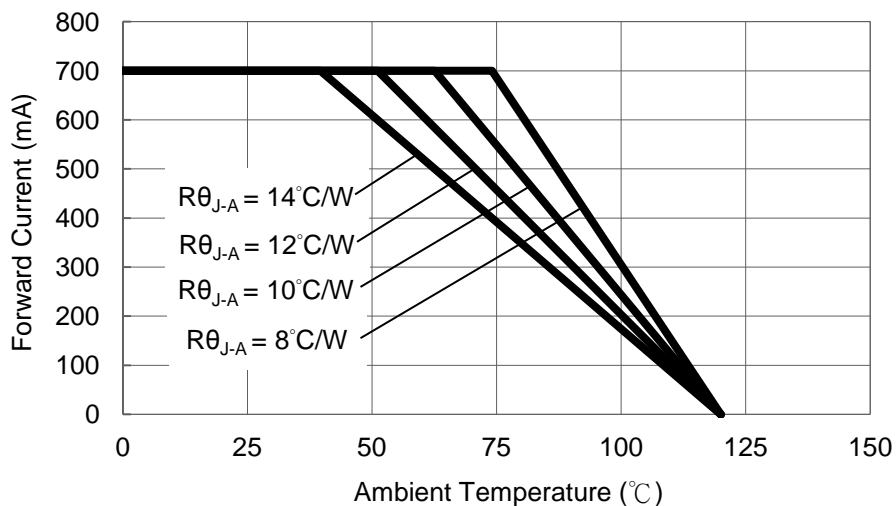


2. Forward Current vs. Normalized Relative Luminous Flux

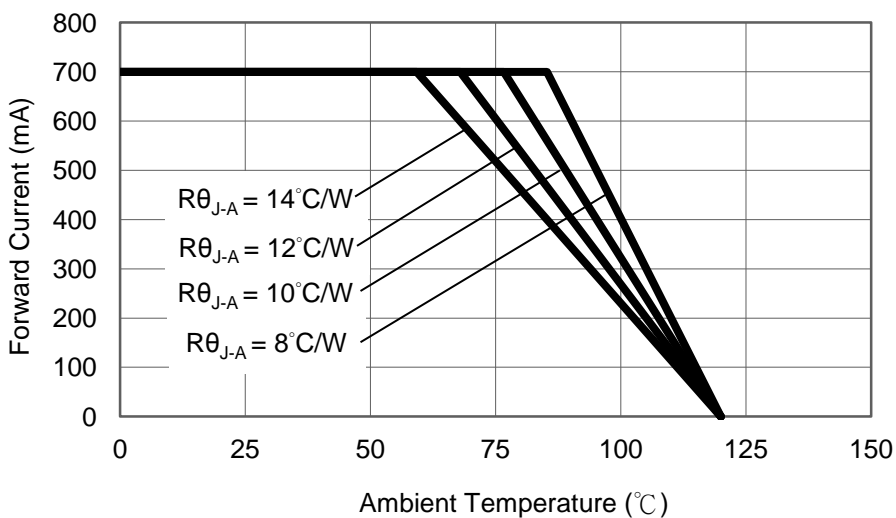


Ambient Temperature vs. Maximum Forward Current

1. White, Warm White, Green, Blue ($T_{JMAX} = 120^{\circ}C$)

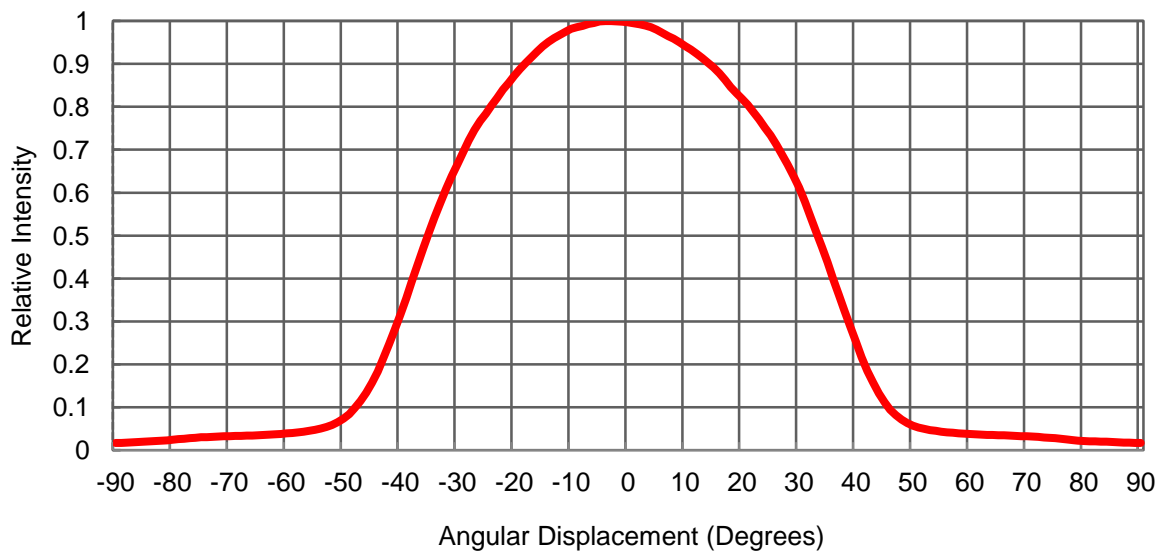


2. Red, Amber ($T_{JMAX} = 120^{\circ}C$)



Typical Representative Spatial Radiation Pattern

Dome Radiation Pattern



Moisture Sensitivity Level - JEDEC Level 2a

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
2a	4 weeks	≤30°C / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH

- The standard soak time includes a default value of 24 hours for semiconductor manufacture's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA
2	1 year	≤30°C / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA
2a	4 weeks	≤30°C / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH
3	168 hours	≤30°C / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH
4	72 hours	≤30°C / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH
5	48 hours	≤30°C / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH
5a	24 hours	≤30°C / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH
6	Time on Label (TOL)	≤30°C / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA

Qualification Reliability Testing

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, $I_F = \text{max DC}$ (Note 1)	1000 hours	Note 2
Wet High Temperature Operating Life (WHTOL)	85°C/60%RH, $I_F = \text{max DC}$ (Note 1)	1000 hours	Note 2
Wet High Temperature Storage Life (WHTSL)	85°C/85%RH, non-operating	1000 hours	Note 2
High Temperature Storage Life (HTSL)	110°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 120°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Non-operating Thermal Shock (TMSK)	-40°C to 120°C, 20 min. dwell, <20 sec. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C ± 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

Notes:

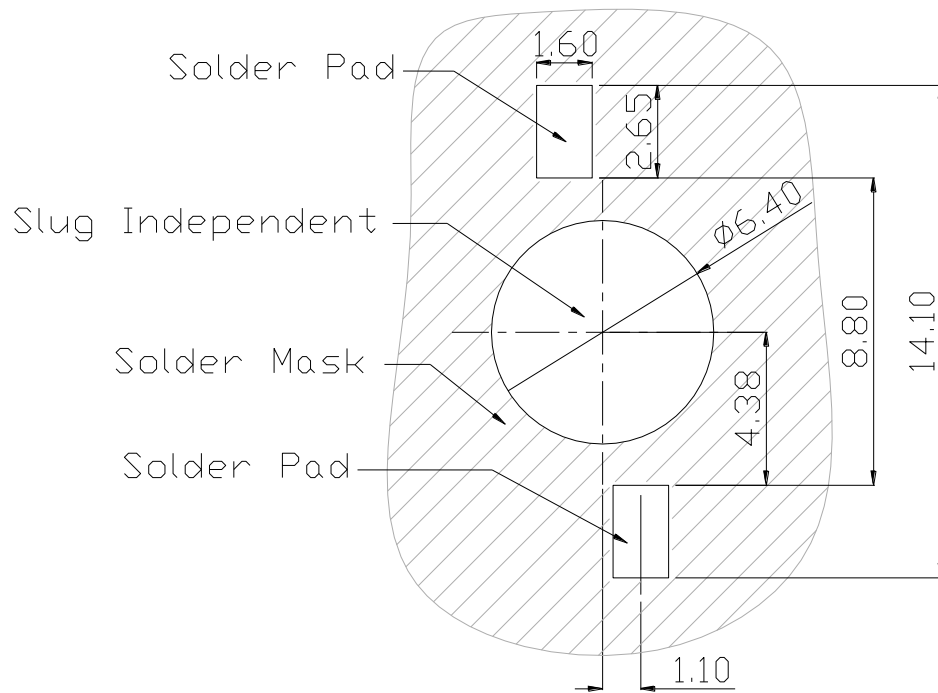
1. Depending on the maximum derating curve.
2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement	
		Min.	Max.
Forward Voltage (V_F)	$I_F = \text{max DC}$	--	Initial Level x 1.1
Luminous Flux or Radiometric Power (Φ_V)	$I_F = \text{max DC}$	Initial Level x 0.7	--
Reverse Current (I_R)	$V_R = 5V$	--	50 μA

* The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

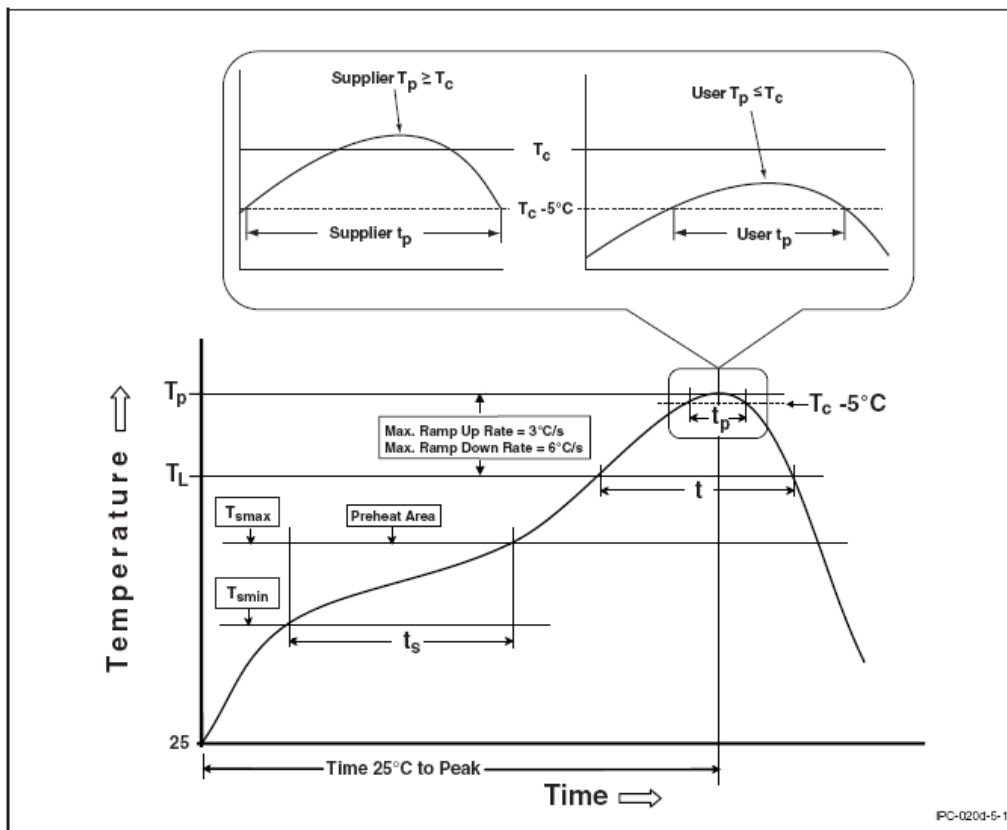
Recommended Solder Pad Design



- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.

Reflow Soldering Condition

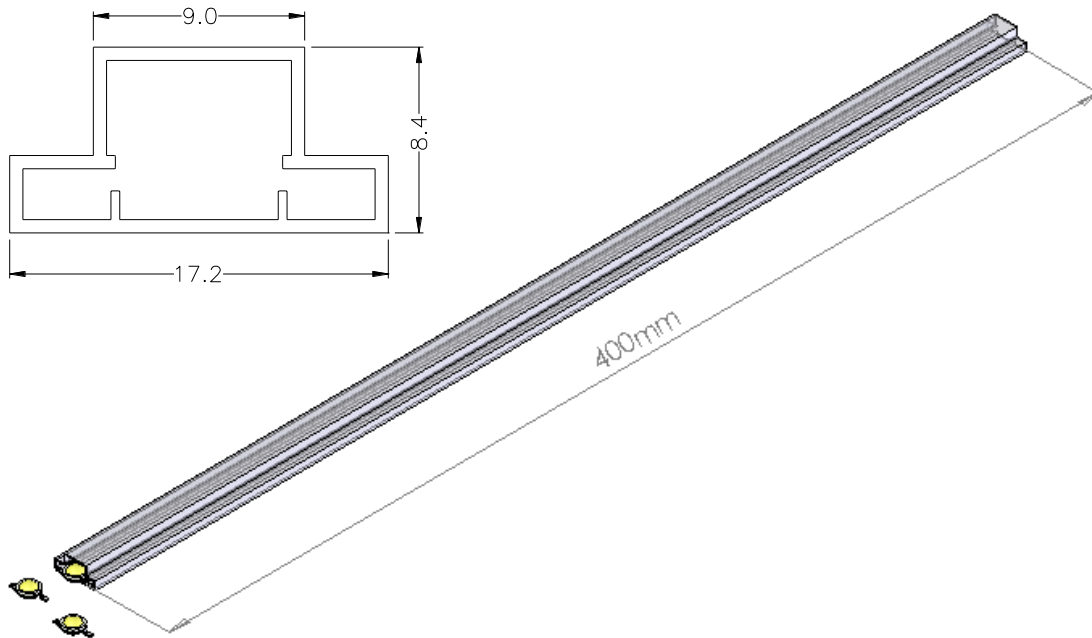
Profile Feature	Sn-Pb Eutectic Assembly	Low-Temp. & Pb-Free Assembly (58Bi-42Sn Eutectic Alloy)
Preheat & Soak		
Temperature min (T_{smin})	100 °C	90 °C
Temperature max (T_{smax})	150 °C	120 °C
Time (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Average Ramp-Up Rate (T_{smax} to T_P)	3 °C / second max.	2 °C / second max.
Liquidous temperature (T_L)	183°C	138°C
Time at liquidous (t_L)	60-150 seconds	20-50 seconds
Peak package body temperature (T_P)	235°C	185°C
Time (t_p) within 5°C of the specified classification temperature (T_C)	20 seconds	20 seconds
Average ramp-down rate (T_P to T_{smax})	6 °C/second max.	3 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	4 minutes max.



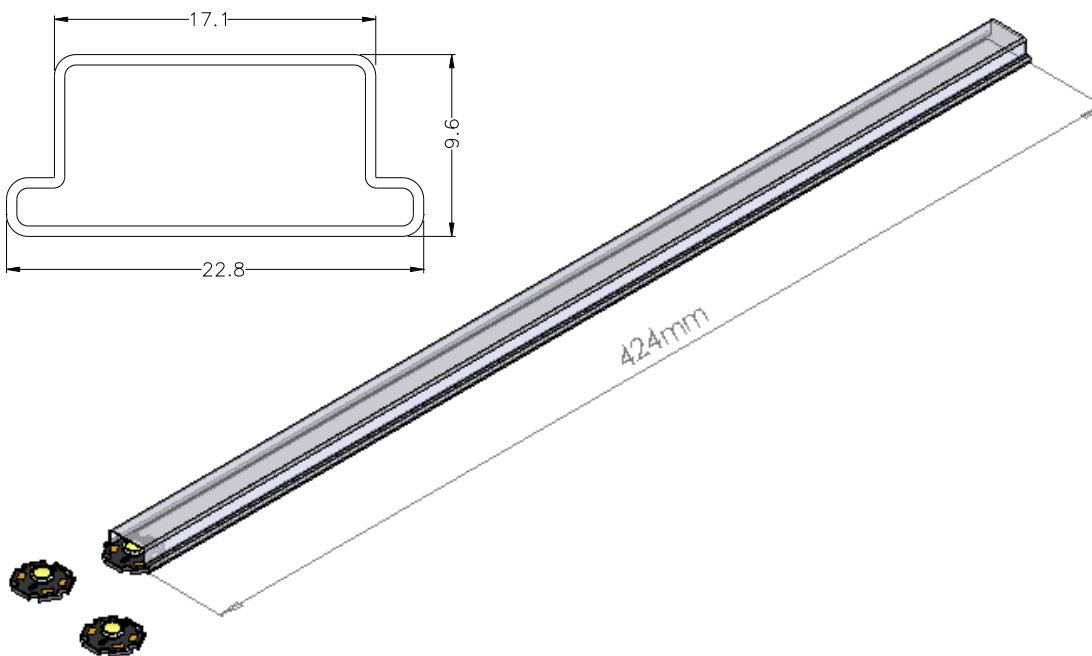
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

ProLight

Emitter Tube Packaging



Star Tube Packaging



Notes:

1. Emitter 50 pieces per tube and Star 20 pieces per tube.
2. Drawing not to scale.
3. All dimensions are in millimeters.
4. All dimensions without tolerances are for reference only.

**Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH.

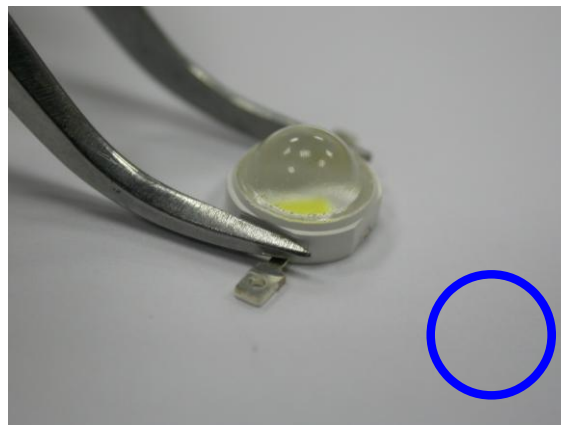
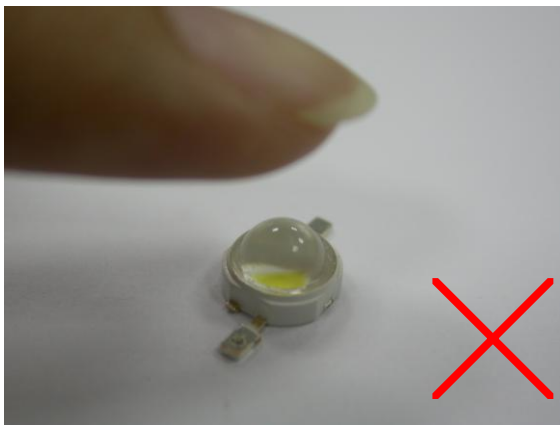
Precaution for Use

- Storage
Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.
- The slug is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets.
<http://www.prolightopto.com/>

Handling of Silicone Lens LEDs

Notes for handling of silicone lens LEDs

- Please do not use a force of over 3kgf impact or pressure on the silicone lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)



ProLight